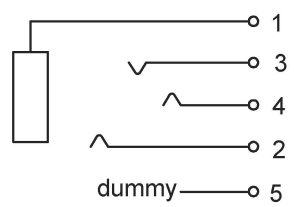


PCB LAYOUT



CIRCUIT DIAGRAM

	MATERIAL	PLATING
terminal 1	Phosphor Bronze	tin
terminal 2	Phosphor Bronze	tin
terminal 3	Phosphor Bronze	tin
terminal 4	Phosphor Bronze	tin
terminal 5	Phosphor Bronze	tin
plastic	High Temp. Thermoplastic	

广东星坤科技股份有限公司

生	日期
效	日期

文件工程章

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES
					ANGLAR ±5°
					L ≤ 4 ±0.2
					4 < L ≤ 16 ±0.3
					16 < L ≤ 63 ±0.4
					L > 63 ±0.5

DSND	DATE	SCALE: N/A	MODEL TYPE: 3.5 PHONE JACK
DWN	DATE	VIEW:	PART NO.:
CHKD	DATE	UNIT: mm/in	DWG NO.: PJ-327E-SMT
APPD	DATE	SIZE: A4	WEIGHT 1.0g
XKB INDUSTRIAL PRECISION CO., LIMITED			SHEET 1/1
			REVISION A0

单击下面可查看定价，库存，交付和生命周期等信息

[>>XKB Connectivity\(中国星坤\)](#)